

2SJ451

Silicon P-Channel MOS FET

HITACHI

ADE-208-382

1st. Edition

Application

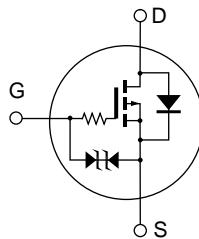
Low frequency power switching

Features

- Low on-resistance.
- Low drive power
- 2.5 V gate drive device.
- Small package (MPAK).

Outline

MPAK



1. Source
2. Gate
3. Drain

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	-20	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	-0.2	A
Drain peak current	$I_{D(pulse)}^{*1}$	-0.4	A
Channel dissipation	Pch	150	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

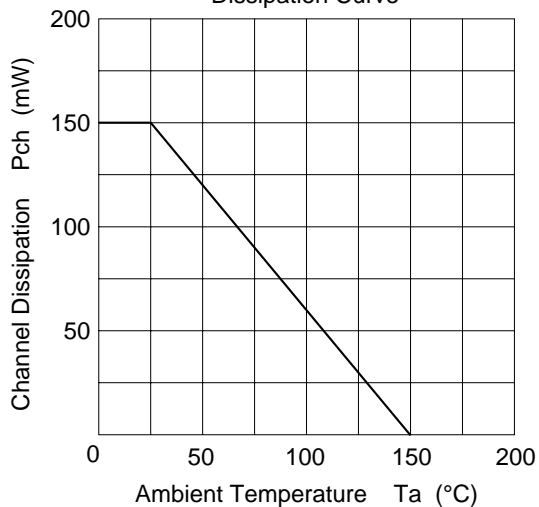
Note: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$
Marking is "ZK-".

Electrical Characteristics (Ta = 25°C)

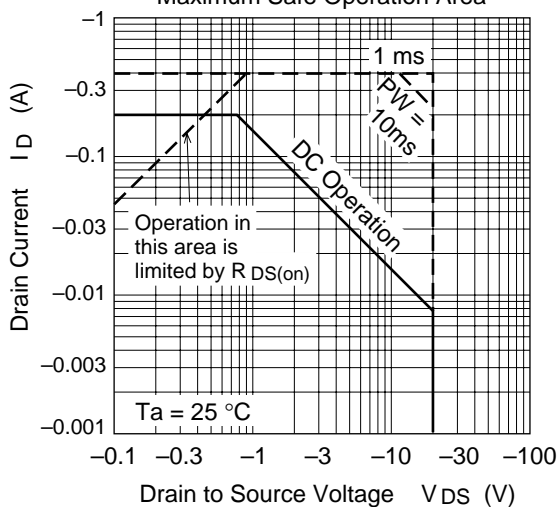
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-20	—	—	V	$I_D = -100 \mu A$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100 \mu A$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-1.0	μA	$V_{DS} = -16 V$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	±2.0	μA	$V_{GS} = \pm 16 V$, $V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-0.5	—	-1.5	V	$I_D = -10 \mu A$, $V_{DS} = -5 V$
Static drain to source on state resistance	$R_{DS(on)1}$	—	2.3	3.5	Ω	$I_D = -100 mA$ $V_{GS} = -4 V^{*1}$
Static drain to source on state resistance	$R_{DS(on)2}$	—	5.0	9.0	Ω	$I_D = -40 mA$ $V_{GS} = -2.5 V^{*1}$
Foward transfer admittance	$ y_{fs} $	0.13	0.23	—	S	$I_D = -100 mA^{*1}$ $V_{DS} = -10 V$
Input capacitance	Ciss	—	2.4	—	pF	$V_{DS} = -10 V$
Output capacitance	Coss	—	31	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	0.6	—	pF	f = 1 MHz
Turn-on delay time	$t_{d(on)}$	—	0.17	—	μs	$V_{GS} = -10 V$, $I_D = -0.1 A$
Rise time	t_r	—	0.68	—	μs	$R_L = 100 \Omega$
Turn-off delay time	$t_{d(off)}$	—	3.0	—	μs	
Fall time	t_f	—	2.8	—	μs	

Note: 1. Pulse Test

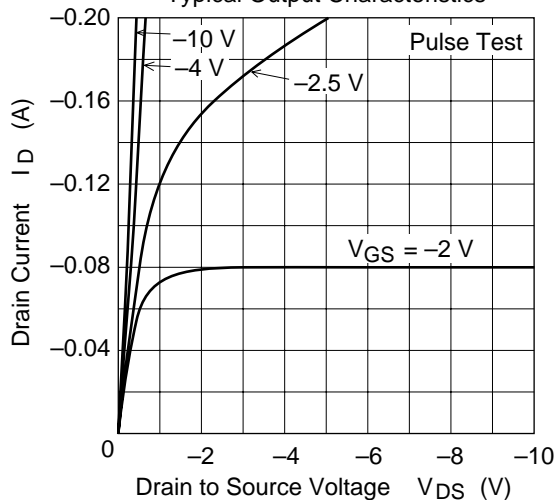
Maximum Channel Dissipation Curve



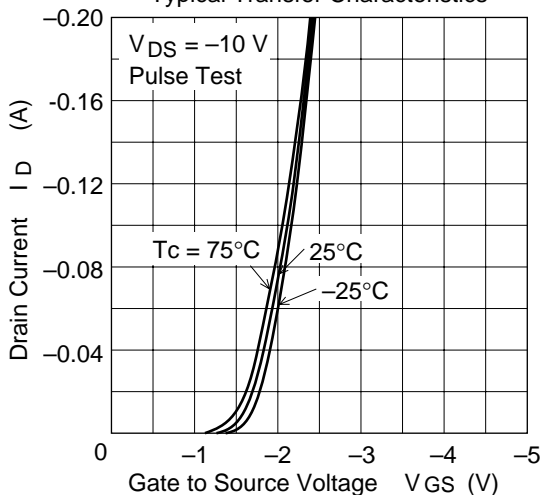
Maximum Safe Operation Area



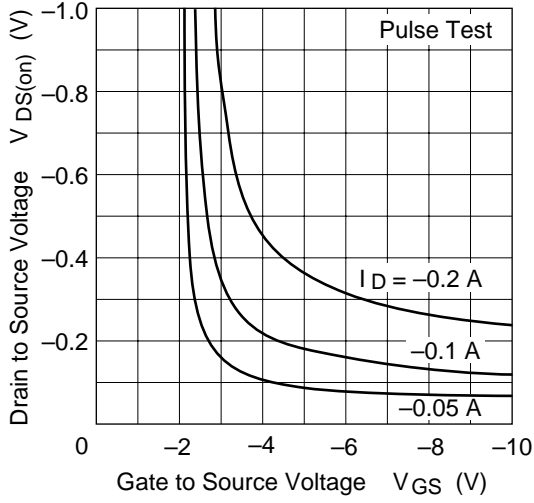
Typical Output Characteristics



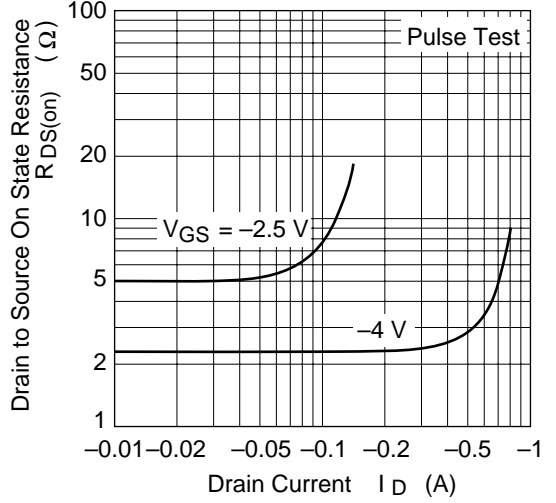
Typical Transfer Characteristics



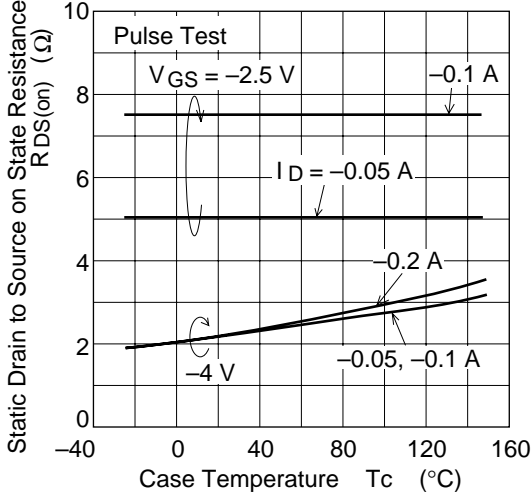
Drain to Source Saturation Voltage vs. Gate to Source Voltage



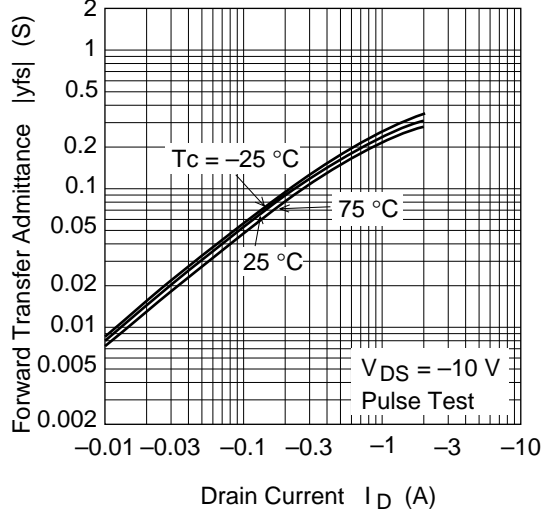
Static Drain to Source on State Resistance vs. Drain Current

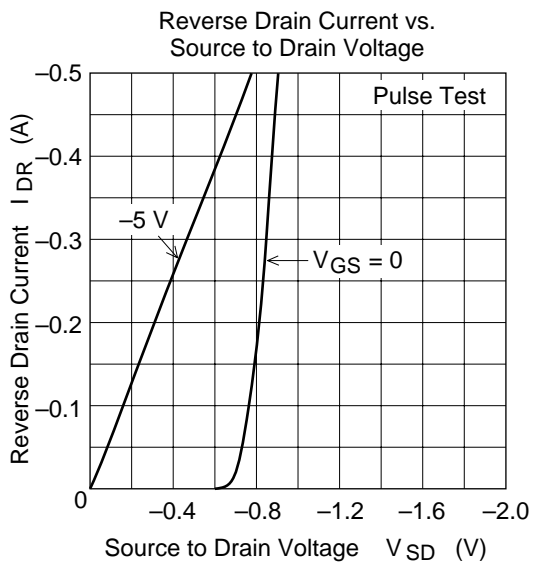
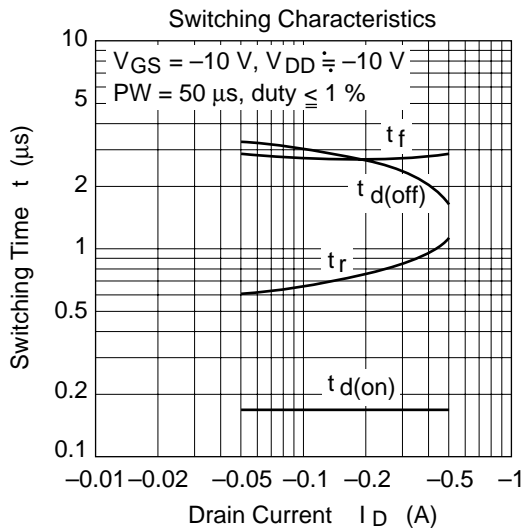
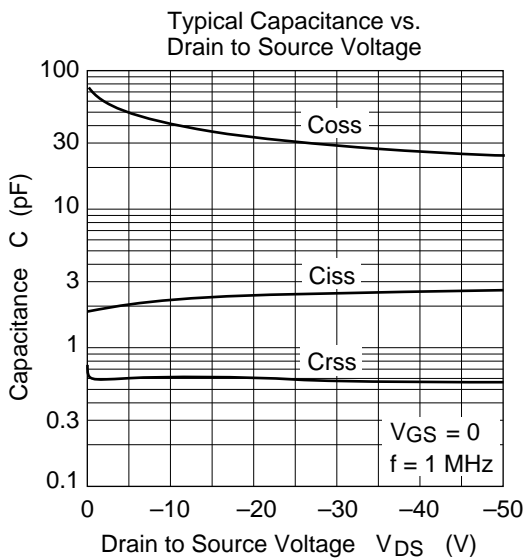


Static Drain to Source on State Resistance vs. Temperature

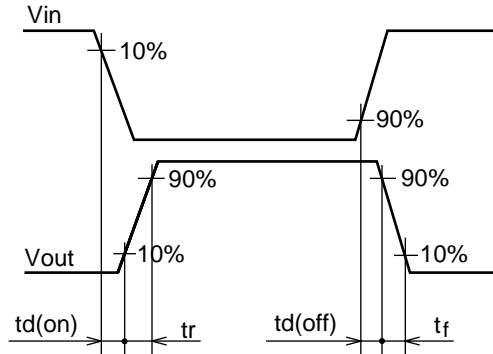
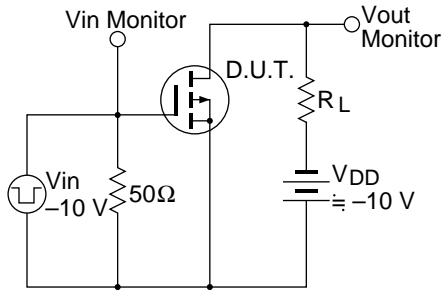


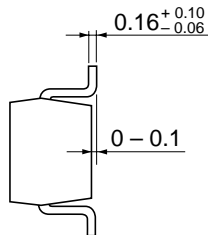
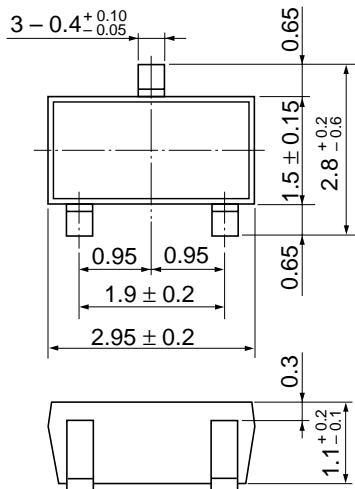
Forward Transfer Admittance vs. Drain Current





Avalanche Test Circuit and Waveform





Hitachi Code	MPAK
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.011 g

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